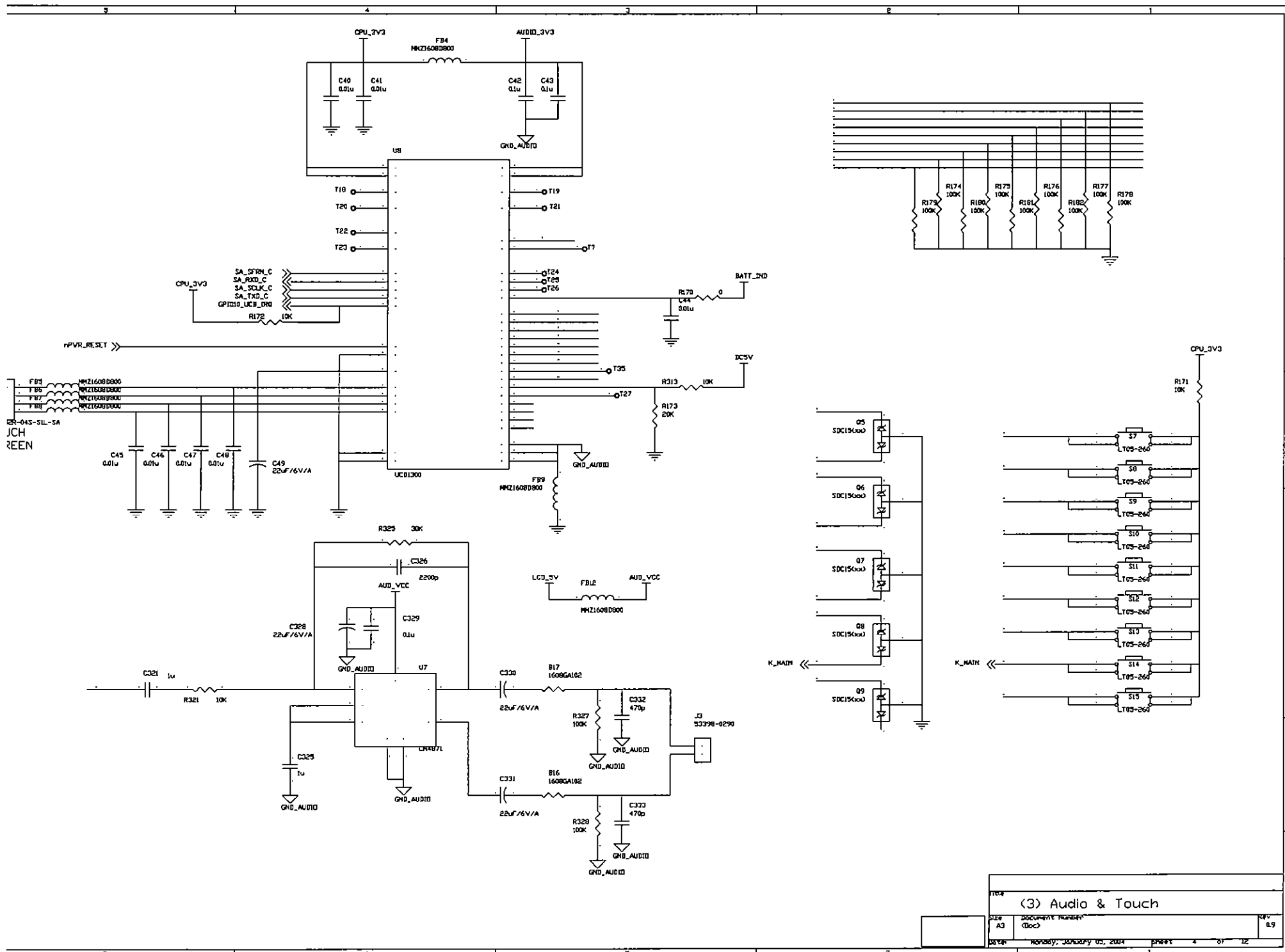
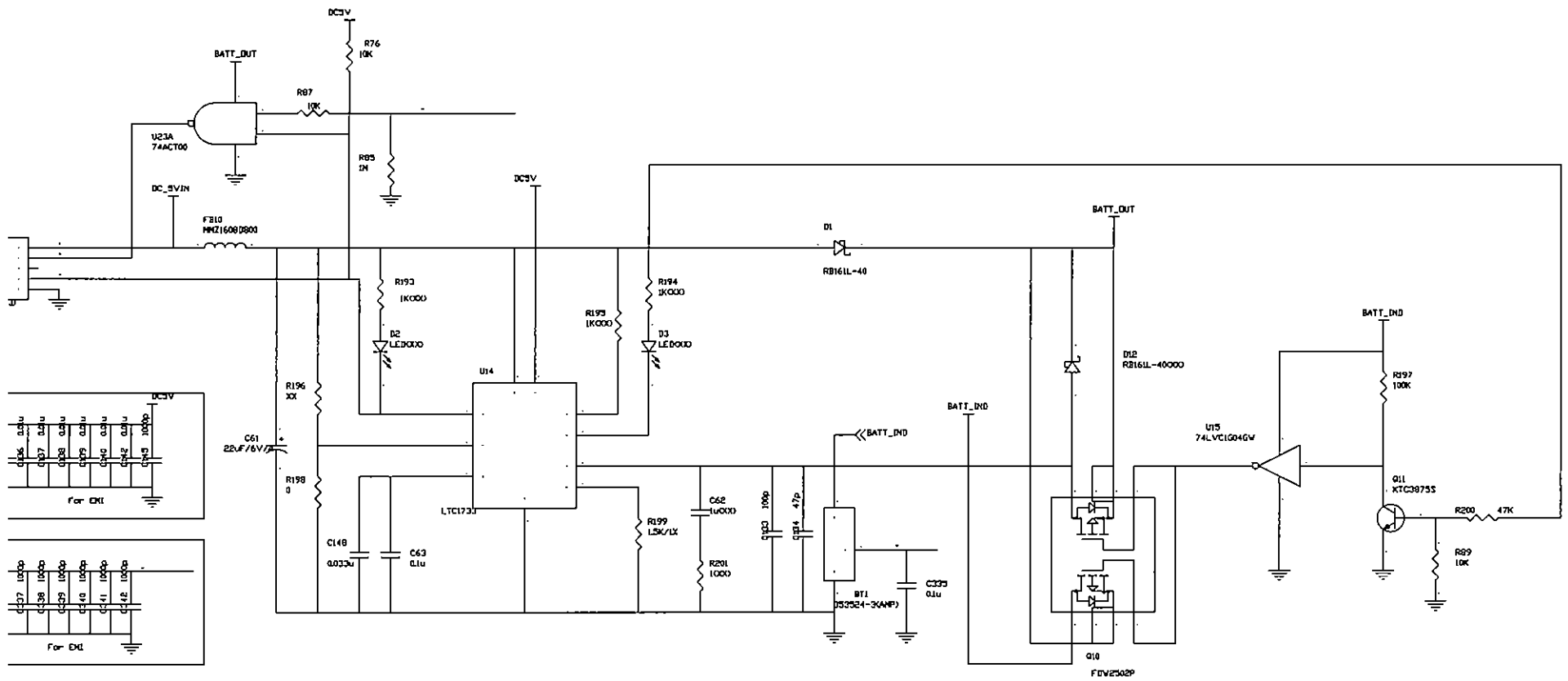
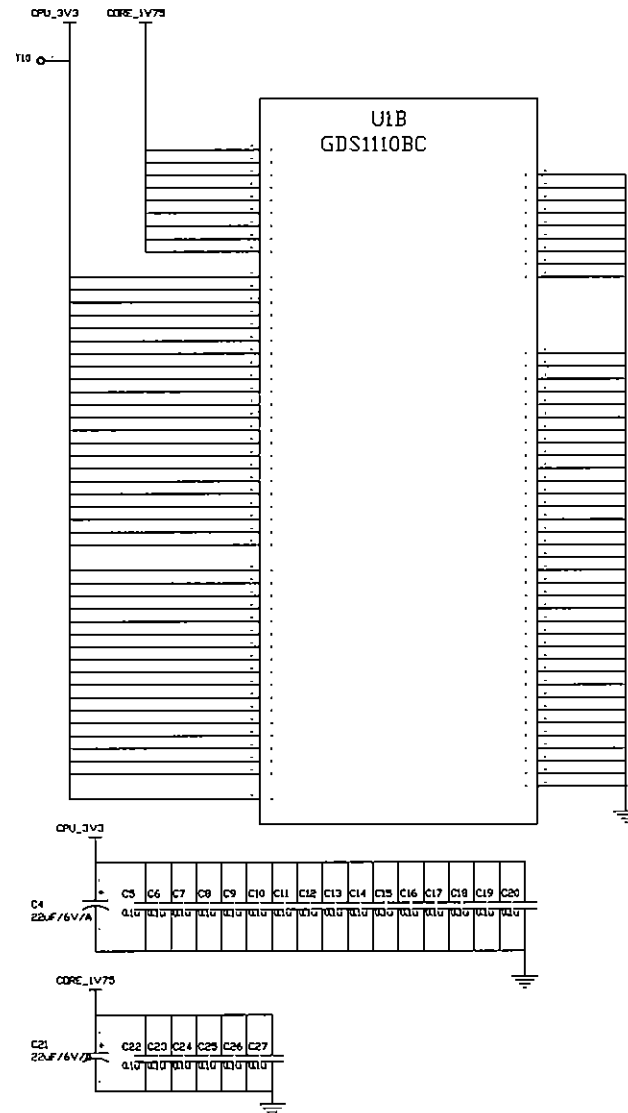


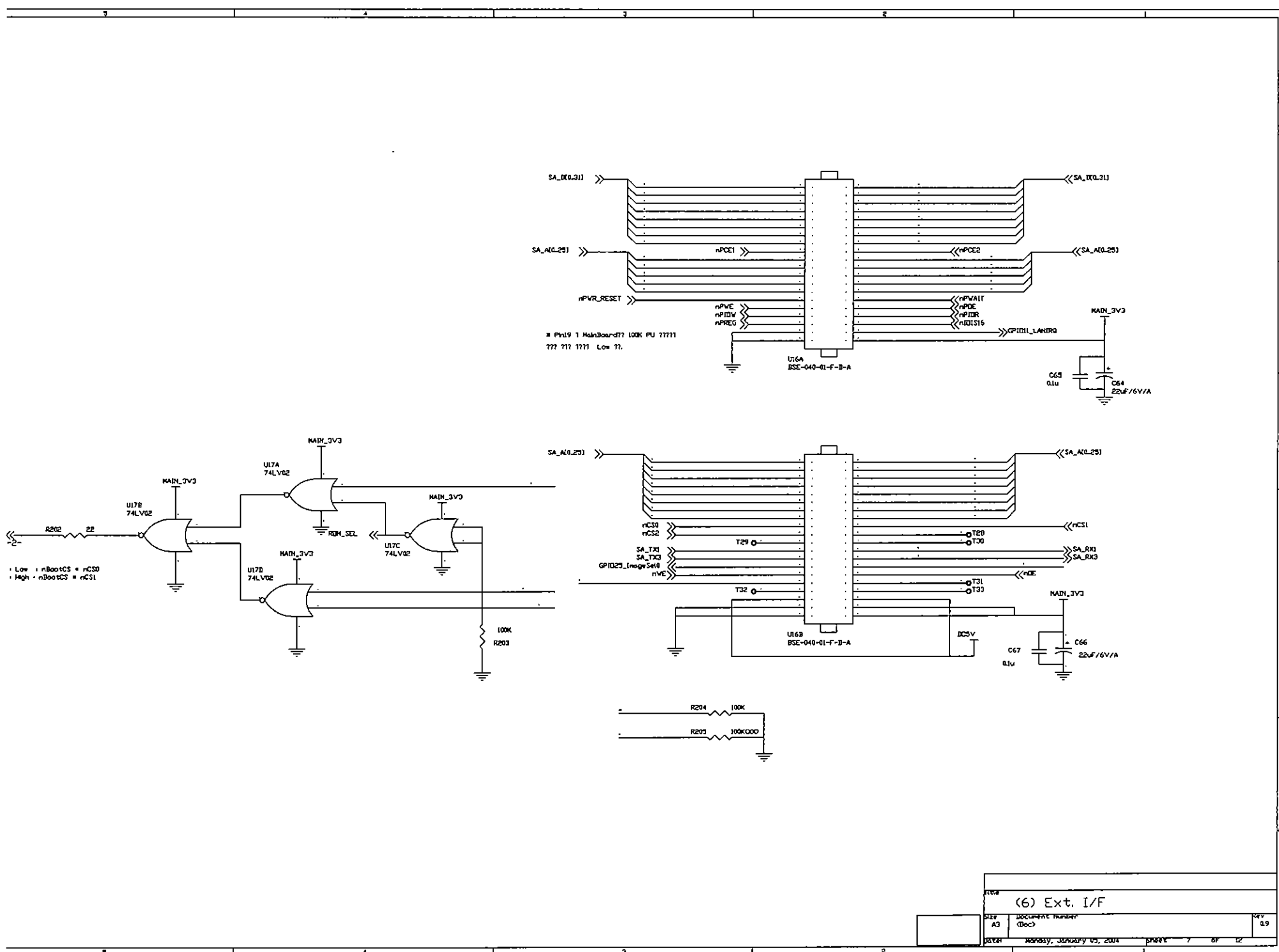




Title					
(5) Battery Control					
Doc	A3	Document Number (Doc)			Rev 0.9
Date	Monday, January 15, 2001			Print	6 of 12

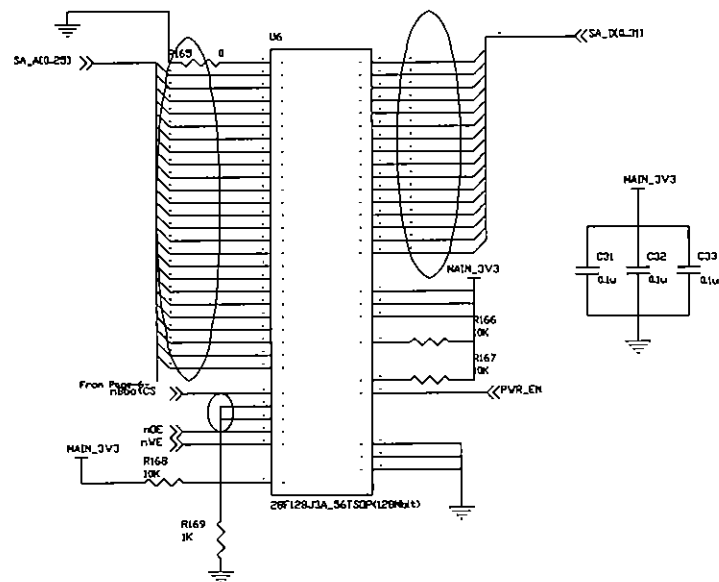
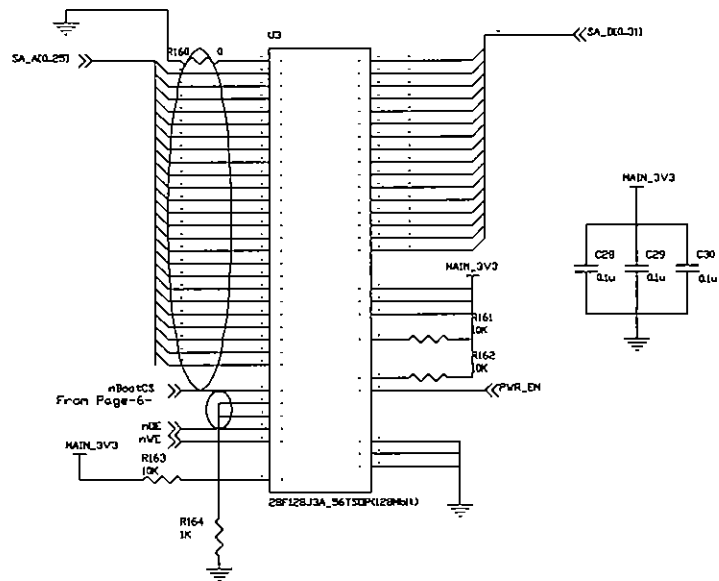


Title		
(1-2) CPU Power&GND Part		
REV	DOCUMENT NUMBER	REV
A3	(Doc)	0.9
DATE	Monday, January 10, 2011	PRINT 2 of 12

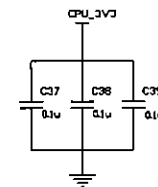
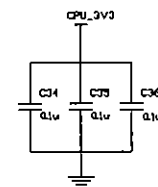
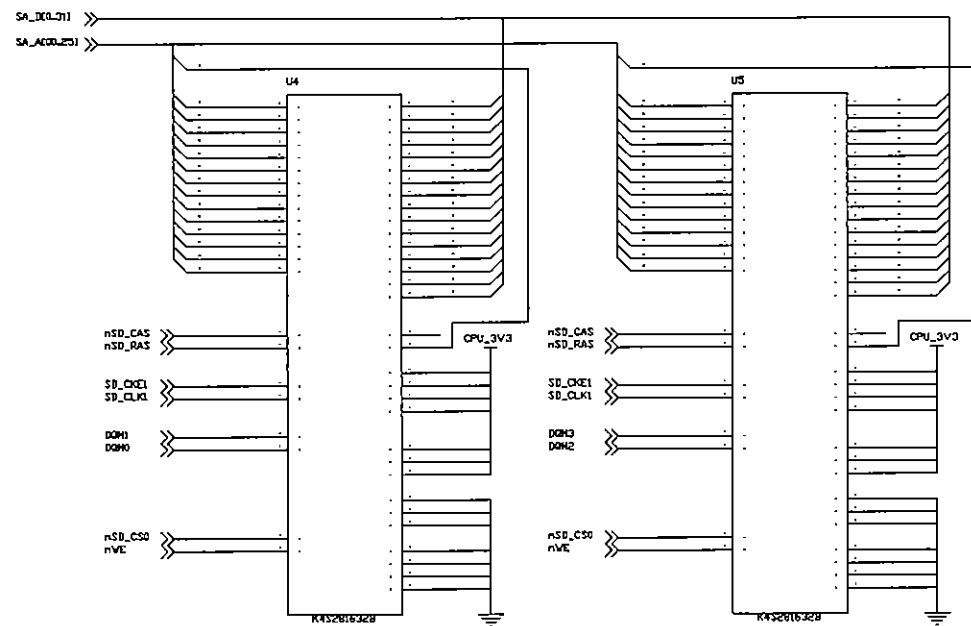


(6) Ext. I/F

REV	DESCRIPTION	DATE
A3	Doc3	Monday, January 03, 2004
0.9		

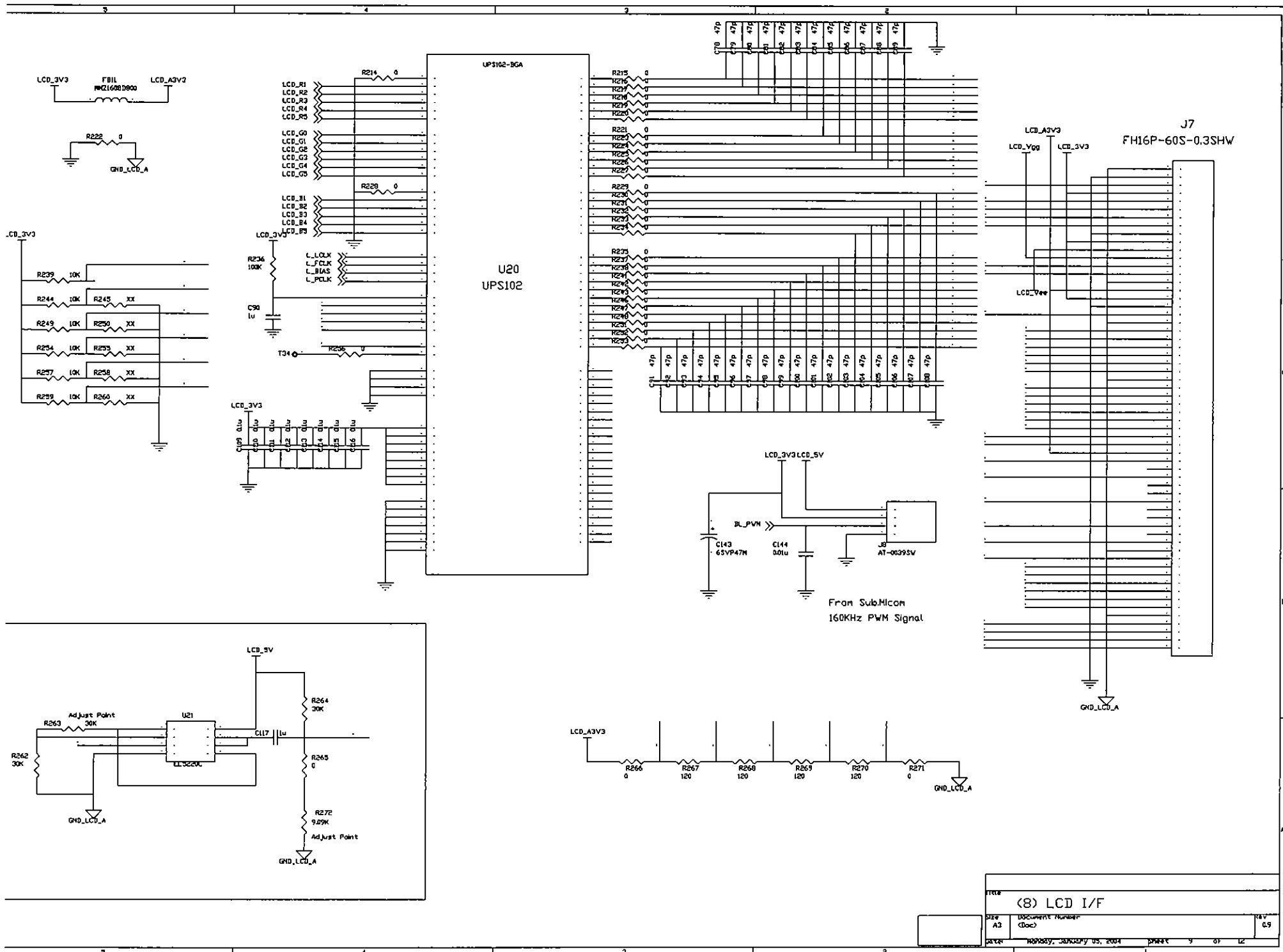


* U8, U9 must be placed as close as possible with CPU.

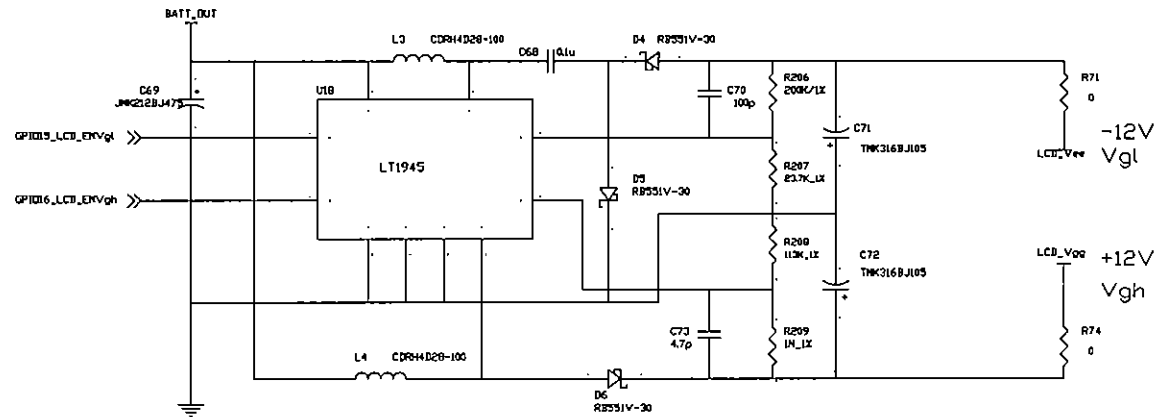


(2)Flash & SDRAM

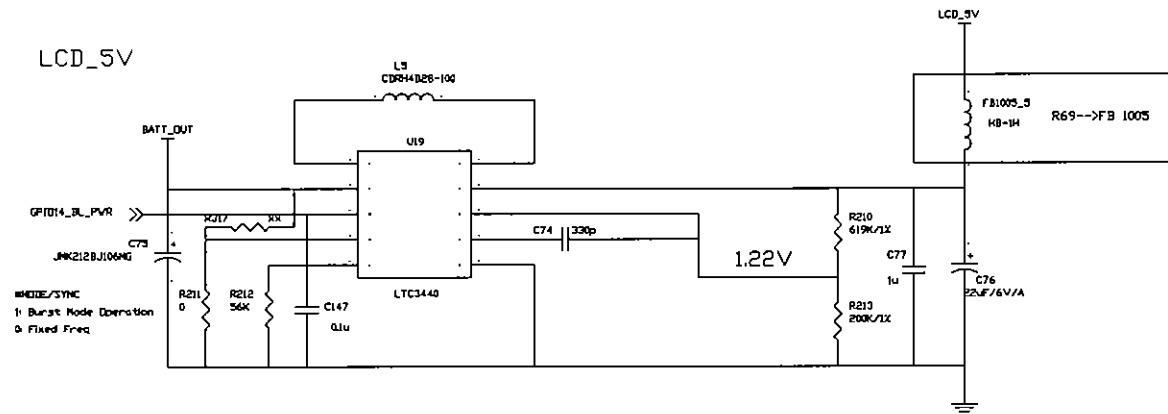
REV	DESCRIPTION	DATE	BY	CHKD	APPD
A3	Document Number (Doc)				
	Monday, January 03, 2001	12	01	01	01



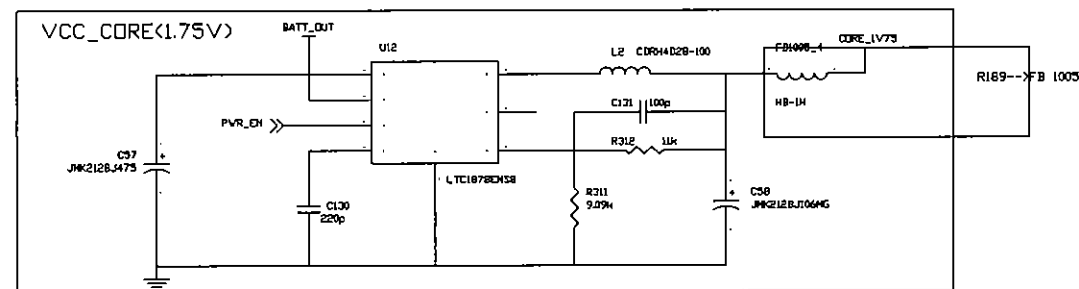
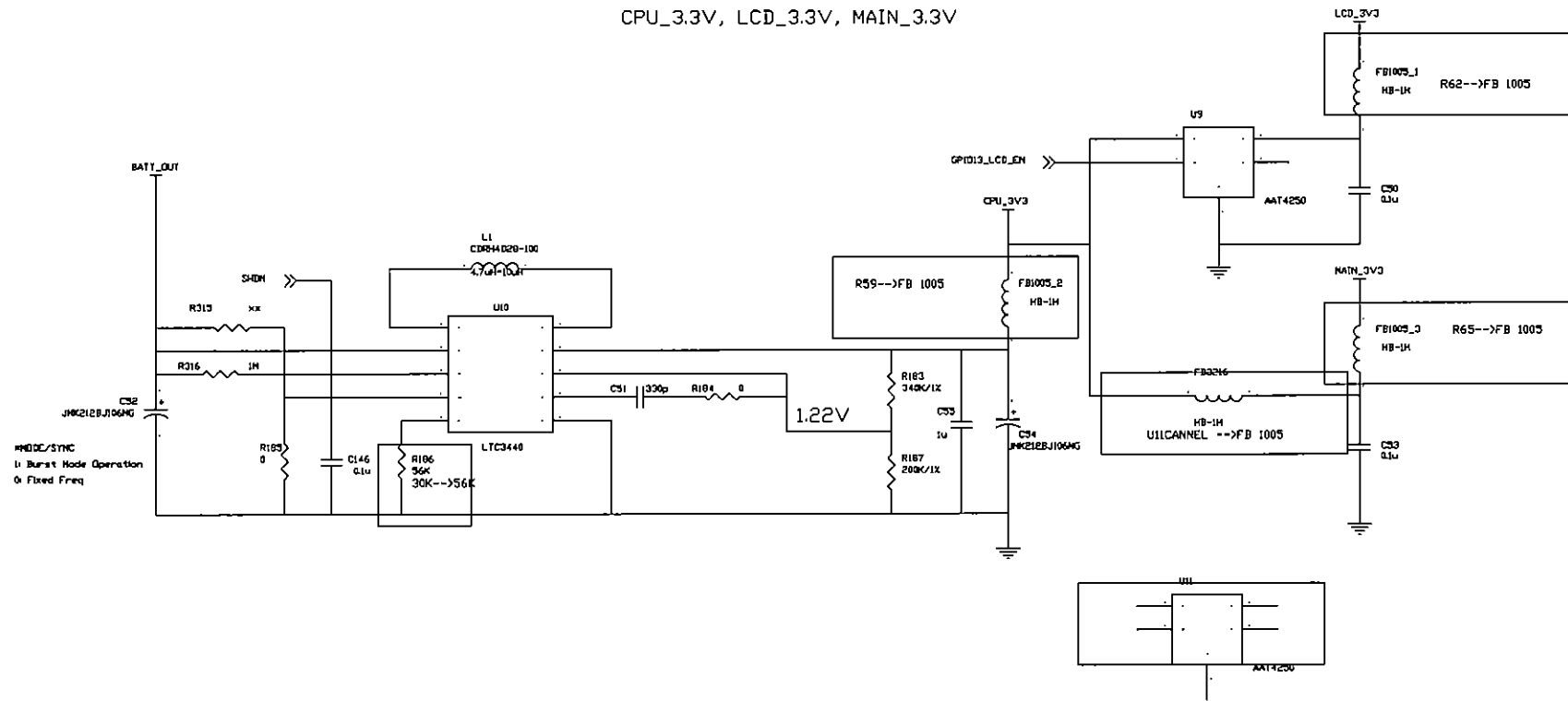
LCD_Vgg/Vee



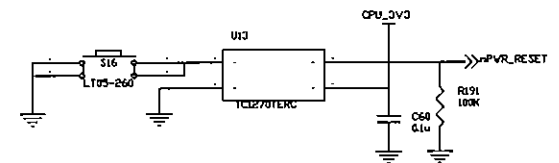
LCD_5V



CPU_3.3V, LCD_3.3V, MAIN_3.3V



RESET

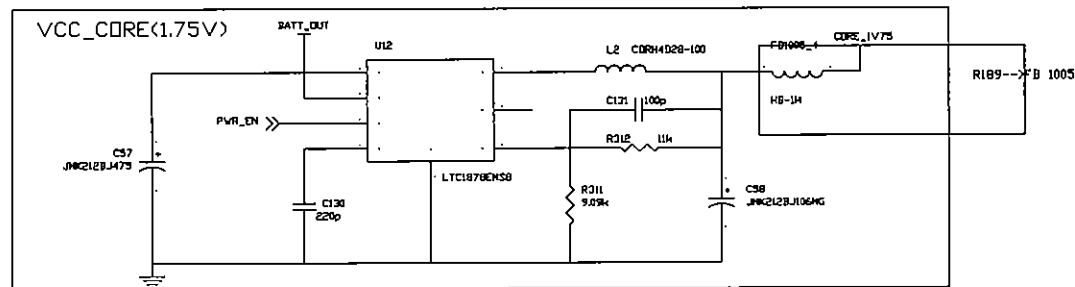
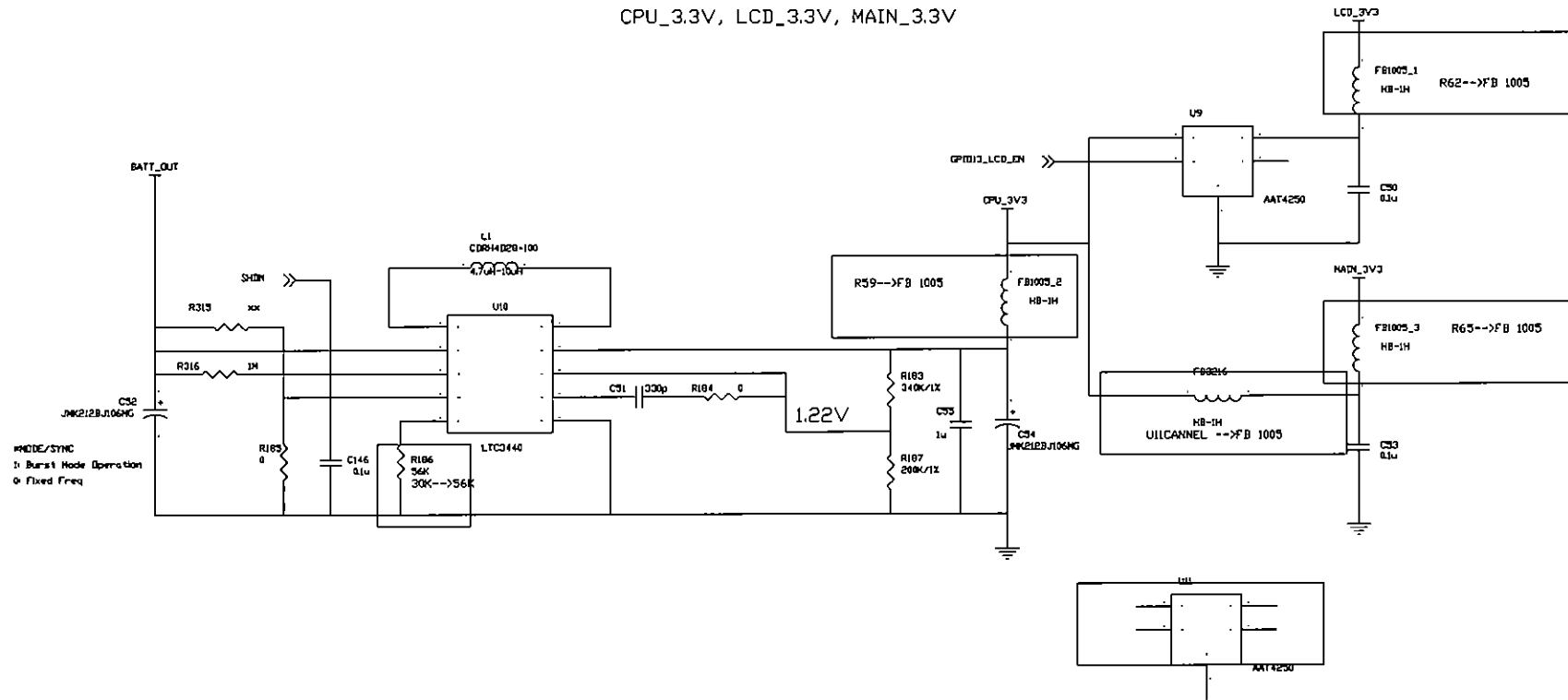


(4) Power & Reset

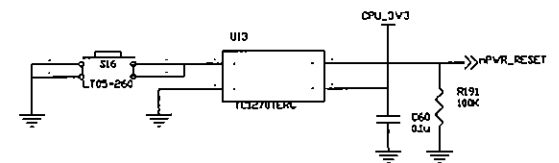
REV	DATE	DESCRIPTION	BY	CHK
A3	2014-01-05	Document Number: (Doc)		

DATE: MONDAY, JANUARY 05, 2014 PAGE: 5 OF 12

CPU_3.3V, LCD_3.3V, MAIN_3.3V



RESET



(4) Power & Reset

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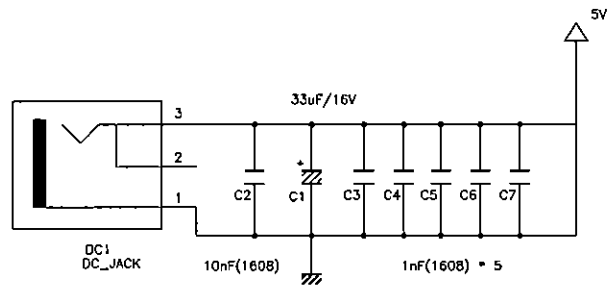
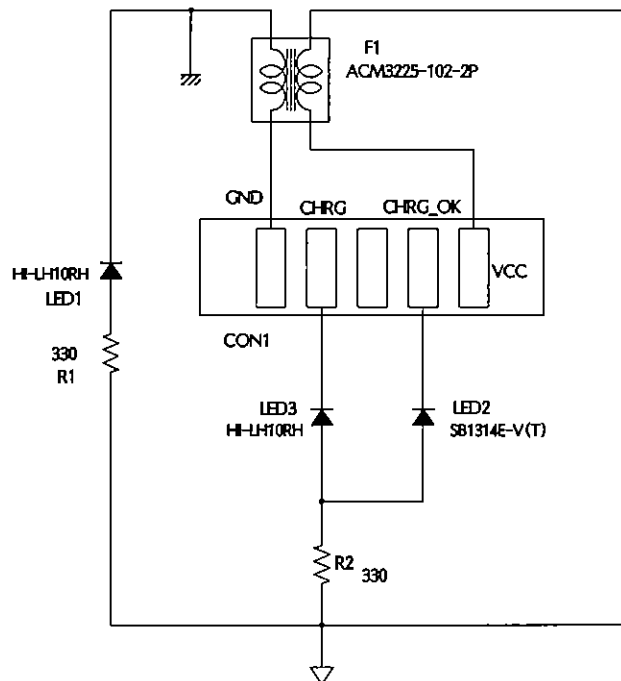
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D	C	B	A	NO.	DESCRIPTION	PART NO.	MATERIAL	Q'TY	SURFACE TREATMENT	REMARK
					CIRCUIT DIAGRAM	3CTM-----		•		•



DATE	AUTHORIZED	CHANGED DETAILS	CHANGED BASIS
SCALE	NS	UNIT	mm
Drafter	Checked	Approved	DESC- RIPTION
류 성 김			MODEL NAME
2003. 02. 06			
OH SUNG ELECTRONICS CO., LTD.	REF. NO.	COMPO	P/NO.
	STOCK NO.		3CTM-----

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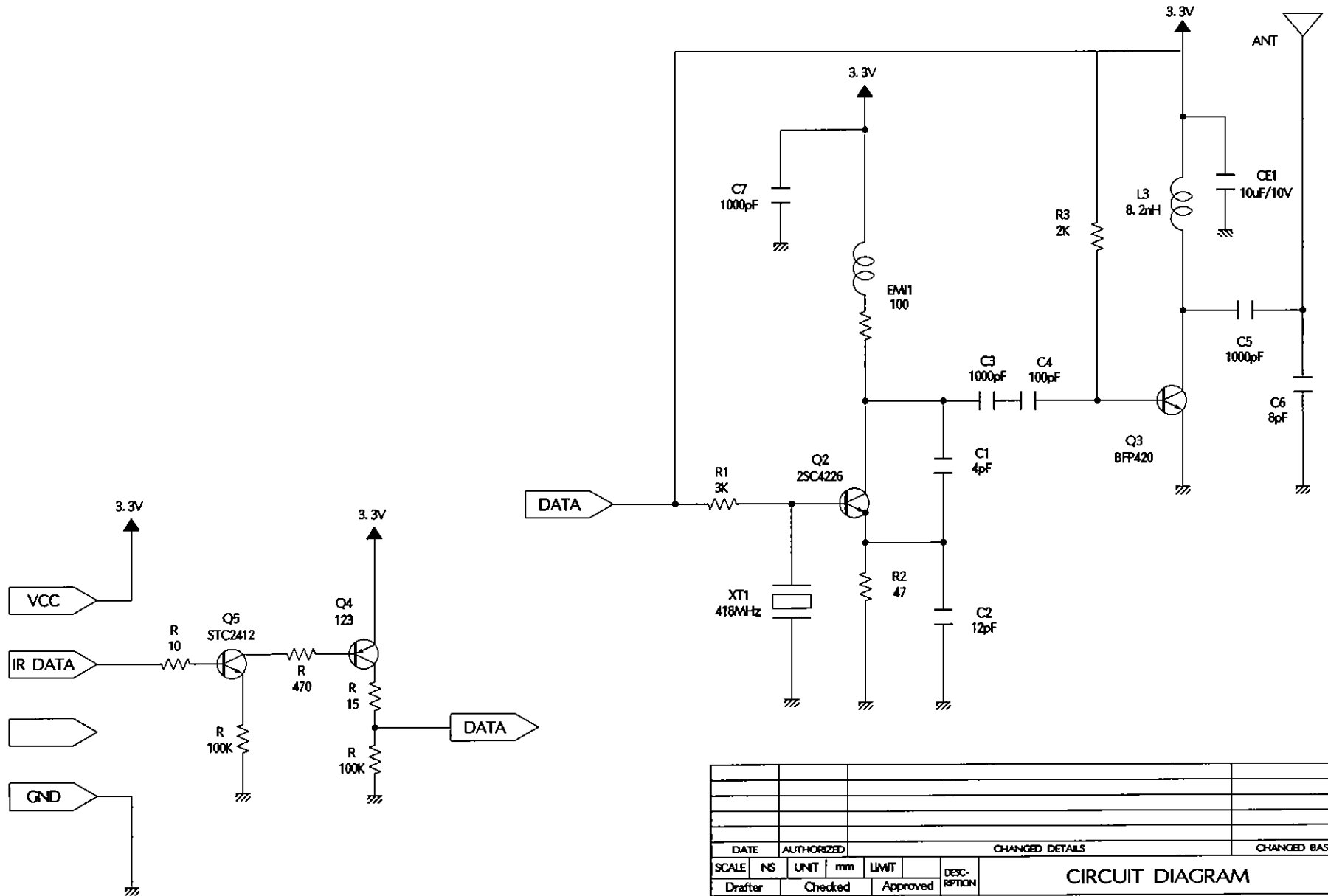
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D	C	B	A	NO.	DESCRIPTION	PART NO.	MATERIAL	Q'TY	SURFACE TREATMENT	REMARK
					CIRCUIT DIAGRAM			.		.



DATE	AUTHORIZED	CHANGED DETAILS	CHANGED BASIS
SCALE	NS	UNIT	mm
Drafter	Checked	Approved	DESCRIPTION
류 성 길			MODEL NAME
2003. 12. 08			
OH SUNG ELECTRONICS CO., LTD.	REF. NO.	COMPO	P/NO.
	STOCK NO.		